

C-Band Internally-Matched Power GaAs FETs (IMFETs) 5.9 to 6.4 GHz

Technical Data

**IM5964-4L
IM5964-8L
IM5964-16L
IM5964-32L**

Features

- **High Output Power:**
 - IM5964-4L:** 36.5 dBm typ. (4.5W)
 - IM5964-8L:** 39.5 dBm typ. (9W)
 - IM5964-16L:** 42.5 dBm typ. (18W)
 - IM5964-32L:** 45.0 dBm typ. (32W)
- **High Power-Added Efficiency:** Up to 42%
- **High Linearity:** -45 dBc IMD₃ @ Specified Output Single Carrier Level
- **Superior Gain Flatness:** ± 0.5 dB max.
- **Linear, Class A Operation**
- **Input and Output Internally Matched To 50 Ohms**
- **Industry Compatible Packages**

Applications

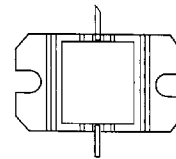
- **Solid State Power Amplifiers for Satellite Earth Station Uplink**
- **Digital Point-to-Point and Point-to-Multipoint Communications**

Description

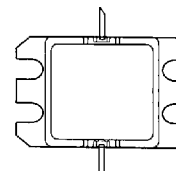
The Hewlett-Packard IM5964-xL series of internally-matched GaAs power FETs, or IMFETs™ is designed to provide efficient power amplification in the 5.9 to 6.4 GHz communications band. Designed for SatCom and Point-to-Point Radio communications, these products offer the system designer benefits associated with higher output power, gain, and net power-added efficiency.^[1] Typical output power of the IM5964-4L exceeds 4 watts, with similar performance advantages for the IM5964-8L, -16L, and -32L models. Higher levels of gain and operating efficiency are the result of leading edge GaAs MESFET technology developed at HP.

HP IMFETs are manufactured using hybrid construction techniques, combining GaAs power MESFETs with low loss, thin-film substrates. Internal 50 ohm matching networks eliminate the RF matching, handling, and die attach difficulties usually associated with using large geometry, high power chip devices. Automated assembly and test proce-

C21A



C24A



dures provide excellent unit-to-unit repeatability and uniformity for easier cascading. HP IMFETs are housed in copper/ceramic packages to allow for maximum heat transfer from the GaAs FET device to the heatsink. The sealing process used is a commercial standard, non-hermetic epoxy, proven for environmental protection. Each unit conforms to the industry's standard outline dimensions. Electrical performance is guaranteed at +25°C.

Note 1: Net power added efficiency = (Pout - Pin)/(Ids x Vds), where Pout and Pin are in watts.

Absolute Maximum Ratings ($T_{\text{Flange}} = 25^{\circ}\text{C}$)

Symbols	Parameters	Units	Ratings			
			IM5964-4L	IM5964-8L	IM5964-16L	IM5964-32L
V_{DS}	Drain to Source Voltage	V	15	15	15	15
V_{GS}	Gate to Source Voltage	V	-10	-10	-10	-10
V_{GD}	Gate to Drain Voltage	V	-15	-15	-15	-15
I_{DS}	Drain Current	A	I_{DSS}	I_{DSS}	I_{DSS}	I_{DSS}
I_{GRF}	Gate Current	mA	± 25	± 50	± 100	± 200
T_{CH}	Max. Channel Temperature	$^{\circ}\text{C}$	175	175	175	175
T_{STG}	Storage Temperature	$^{\circ}\text{C}$	-65 to +150	-65 to +150	-65 to +150	-65 to +150
$P_{\text{T}}^{[2]}$	Total Power Dissipation	W	31	38	83	150

Electrical Characteristics ($T_{\text{Flange}} = 25^{\circ}\text{C}$)

Symbols	Parameters	Units	IM5964-4L			IM5964-8L			Test Conditions
			Min.	Typ.	Max.	Min.	Typ.	Max.	
P1dB	Output Power @ 1 dB Gain Compression $I_{\text{DSQ}} = 1.0\text{A}$ $I_{\text{DSQ}} = 2.0\text{A}$	dBm dBm	36.0	36.5		39.0	39.5		$V_{\text{DS}} = 10.0\text{ V}$ Freq. = 5.9 – 6.45 GHz $Z_{\text{S}} = Z_{\text{L}} = 50\text{ ohms}$ $R_{\text{G}} = 20\text{ ohms}$
η_{ADD}	Power-Added Efficiency @ 1 dB Gain Compression	%		42			40		
I_{DS}	Drain Current @ P1dB	A		1.1	1.5		2.2	3.0	
G1dB	Power Gain @ 1 dB Gain Compression	dB	8.5	9.5		8.0	9.0		
ΔG	Gain Flatness	dB		± 0.3	± 0.5		± 0.3	± 0.5	
IMD_3	3rd Order Intermod Distortion $P_{\text{out SCL}}^{[1]}$ I_{DSQ} 26 dBm 1.0 A 29 dBm 2.0 A	dBc dBc		-45	-42		-45	-42	$V_{\text{DS}} = 10.0\text{ V}$ Two Equal Tone Test $f_1 = 6.44\text{ GHz}$ $f_2 = 6.45\text{ GHz}$
I_{DSS}	Saturated Drain Current	A	1.5	2.5	3.5	3.0	5.0	7.0	$V_{\text{GS}} = 0\text{ V}; V_{\text{DS}} = 2.5\text{ V}$
V_{P}	Pinch Off Voltage $I_{\text{DS}} = 63\text{ mA}$ $I_{\text{DS}} = 125\text{ mA}$	V V	-4.5	-3.0	-1.5	-4.5	-3.0	-1.5	$V_{\text{DS}} = 2.5\text{ V}$
BV_{GDO}	Gate-Drain Breakdown Voltage $I_{\text{GD}} = -6\text{ mA}$ $I_{\text{GD}} = -12\text{ mA}$	V V	-16.0			-16.0			
g_{m}	Transconductance $I_{\text{DS}} = 1.0\text{ A}$ $I_{\text{DS}} = 2.0\text{ A}$	S S		1.3			2.5		$V_{\text{DS}} = 2.5\text{ V}$
R_{TH}	Thermal Resistance (Channel to Flange)	$^{\circ}\text{C}/\text{W}$		4.9			4.0		I. R. Method; $V_{\text{DS}} = 10.0\text{ V}$ $I_{\text{DS}} = 1\text{ and }2\text{ A}$
ΔT	Temperature Rise Channel to Flange; DC on & RF off	$^{\circ}\text{C}$		49			80		I. R. Method
	Case Style		C21A			C21A			

Notes:

- SCL: Single Carrier Level
- See Application Note, AN 1083

Electrical Characteristics ($T_{\text{Flange}} = 25^{\circ}\text{C}$)

Part Number		IM5964-16L			IM5964-32L				
Symbols	Parameters	Units	Min.	Typ.	Max.	Min.	Typ.	Max.	Test Conditions
P1dB	Output Power @ 1 dB Gain Compression $I_{\text{DSQ}} = 4.0\text{A}$ $I_{\text{DSQ}} = 8.0\text{A}$	dBm dBm	41.5	42.5		44.5	45.0		$V_{\text{DS}} = 10.0\text{ V}$ Freq. = 5.9 – 6.45 GHz $Z_{\text{s}} = Z_{\text{l}} = 50\text{ ohms}$ $R_{\text{G}} = 5\text{ ohms}$
η_{ADD}	Power-Added Efficiency @ 1 dB Gain Compression	%		38			36		
I_{DS}	Drain Current @ P1dB	A		4.4	6.0		8.8	12.0	
G1dB	Power Gain @ 1 dB Gain Compression	dB	8.0	9.0		7.5	8.5		
ΔG	Gain Flatness	dB		± 0.3	± 0.5		± 0.3	± 0.5	
IMD ₃	3rd Order Intermod Distortion $P_{\text{out SCL}}^{(1)}$ I_{DSQ} 31.5 dBm 4.0 A 34.5 dBm 8.0 A	dBc dBc		-45	-42		-45	-42	$V_{\text{DS}} = 10.0\text{ V}$ Two Equal Tone Test $f_1 = 6.44\text{ GHz}$ $f_2 = 6.45\text{ GHz}$
I_{DSS}	Saturated Drain Current	A	6.0	10.0	14.0	12.0	20.0	28.0	$V_{\text{GS}} = 0\text{ V}; V_{\text{DS}} = 2.5\text{ V}$
V_{P}	Pinch Off Voltage $I_{\text{DS}} = 250\text{ mA}$ $I_{\text{DS}} = 500\text{ mA}$	V V	-4.5	-3.0	-1.5	-4.5	-3.0	-1.5	$V_{\text{DS}} = 2.5\text{ V}$
BV_{GDO}	Gate-Drain Breakdown Voltage $I_{\text{GD}} = -25\text{ mA}$ $I_{\text{GD}} = -50\text{ mA}$	V V	-16.0			-16.0			
g_{m}	Transconductance $I_{\text{DS}} = 4.0\text{ A}$ $I_{\text{DS}} = 8.0\text{ A}$	S S		5.0			10.0		$V_{\text{DS}} = 2.5\text{ V}$
R_{TH}	Thermal Resistance (Channel to Flange)	$^{\circ}\text{C}/\text{W}$		1.8			1.0		I. R. Method; $V_{\text{DS}} = 10.0\text{ V}$ $I_{\text{DS}} = 4\text{ and }8\text{ A}$
ΔT	Temperature Rise Channel to Flange; DC on & RF off	$^{\circ}\text{C}$		72			80		I. R. Method
	Case Style		C24A			C24A			

Notes:

- SCL: Single Carrier Level
- See Application Note, AN 1083

Typical Performance ($T_{Flange} = 25^{\circ}C$)

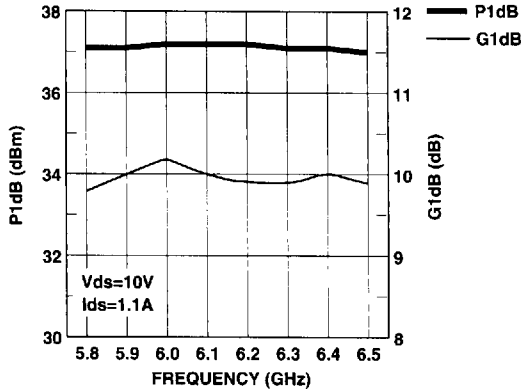


Figure 1. IM5964-4L Output Power, Gain vs. Frequency.

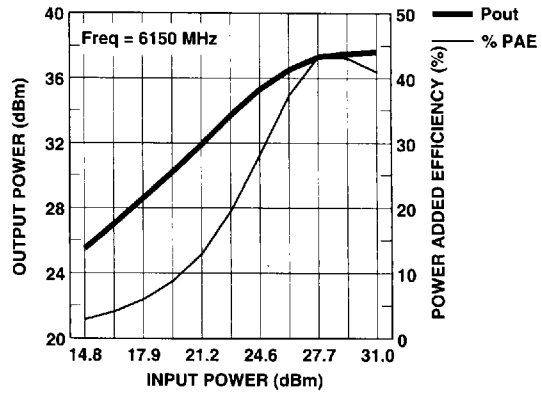


Figure 2. IM5964-4L Output Power, Power Added Efficiency vs. Input Power.

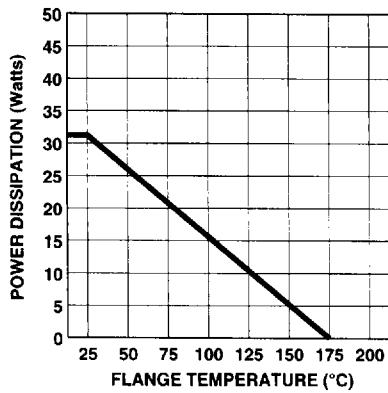


Figure 3. IM5964-4L Maximum Total Power Dissipation vs. Flange Temperature.

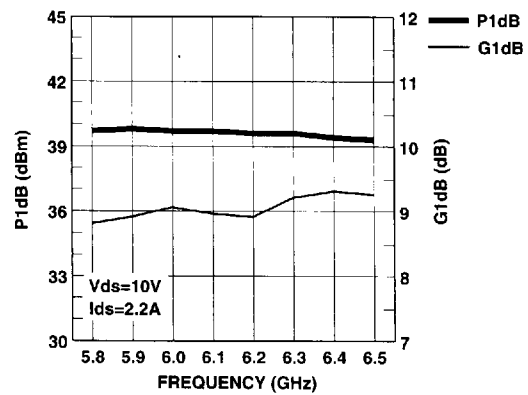


Figure 4. IM5964-8L Output Power, Gain vs. Frequency.

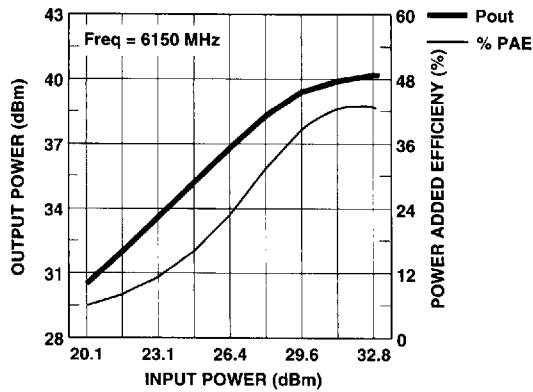


Figure 5. IM5964-8L Output Power, Power Added Efficiency vs. Input Power.

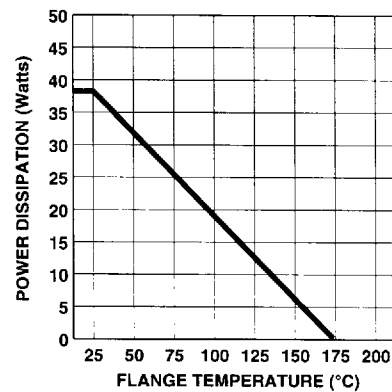


Figure 6. IM5964-8L Maximum Total Power Dissipation vs. Flange Temperature.

Typical Performance ($T_{Flange} = 25^{\circ}C$)

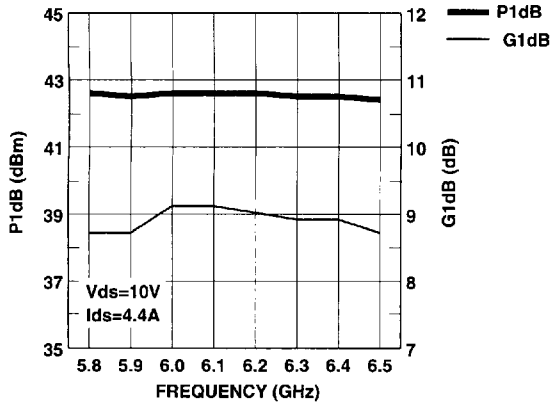


Figure 7. IM5964-16L Output Power, Gain vs. Frequency.

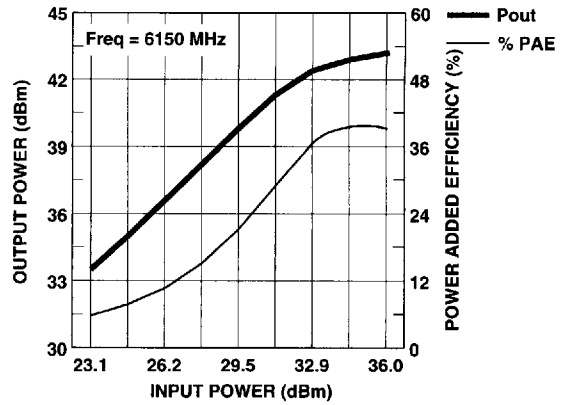


Figure 8. IM5964-16L Output Power, Power Added Efficiency vs. Input Power.

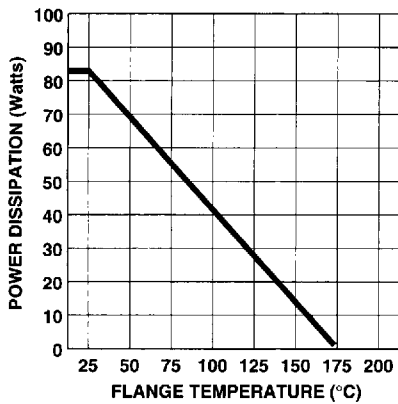


Figure 9. IM5964-16L Maximum Total Power Dissipation vs. Flange Temperature.

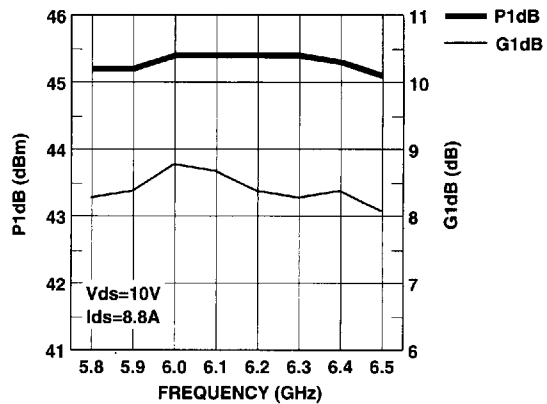


Figure 10. IM5964-32L Output Power, Gain vs. Frequency.

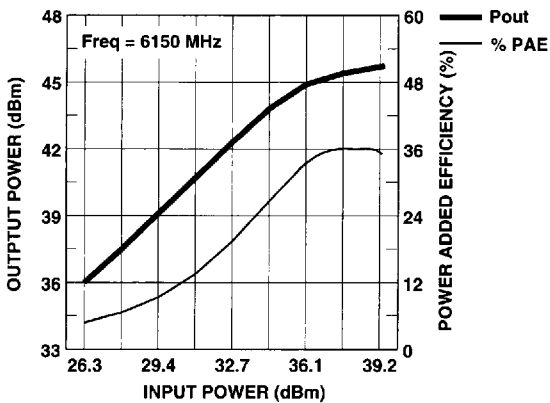


Figure 11. IM5964-32L Output Power, Power Added Efficiency vs. Input Power.

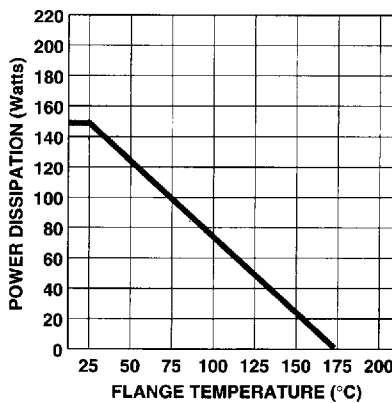
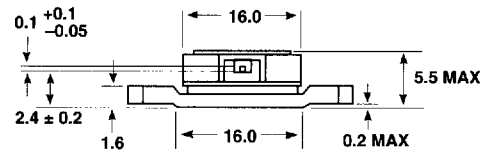
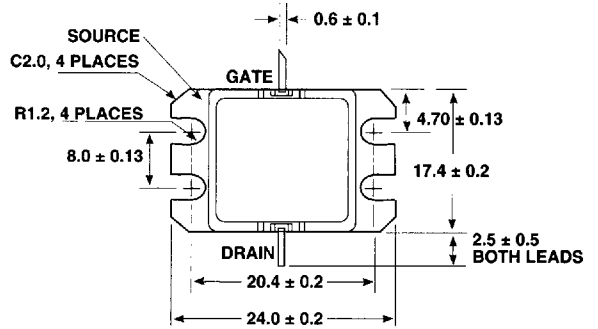
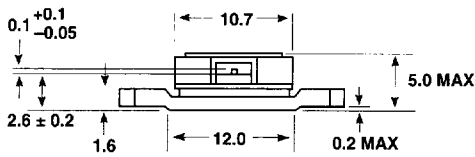
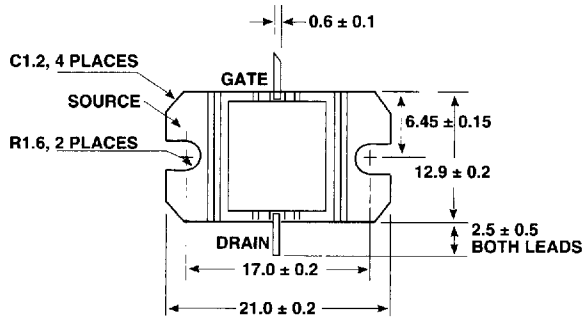


Figure 12. IM5964-32L Maximum Total Power Dissipation vs. Flange Temperature.

Case Dimensions



NOTES (UNLESS OTHERWISE SPECIFIED):
1. DIMENSIONS ARE SPECIFIED IN mm

**Figure 13. C21A Package Outline
IM5964-4L and IM5964-8L.**

**Figure 14. C24A Package Outline
IM5964-16L and IM5964-32L.**

For technical assistance or the location of your nearest Hewlett-Packard sales office, distributor or representative call:

Americas/Canada: 1-800-235-0312 or 408-654-8675

Far East/Australasia: (65) 290-6305

Japan: (81 3) 3335-8152

Europe: Call your local HP sales office.

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Obsoletes 5964-9705E (3/96)
Printed in U.S.A. 5965-3161E (7/96)